Influence of TiO₂ Additives on the Microstructure of In₂O₃ Ceramics

Nicolas Nadaud & Philippe Boch

Laboratory of Ceramics and Inorganic Materials, Ecole Supérieure de Physique et de Chimie Industrielles de Paris, 10, rue Vauquelin, 75005, France

(Received 26 June 1995; accepted 3 August 1995)

Abstract: Titania additives favour densification and hinder grain growth in indium oxide ceramics. The influence of TiO_2 has been investigated, using specimens made by stacking two layers against each other, one of In_2O_3 and the other of $(TiO_2)_x$ – $(In_2O_3)_{1-x}$. After sintering, the sharp interface is replaced by a diffuse one, with a graded concentration of TiO_2 . Both porosity and grain size decrease when the TiO_2 content increases.

1 INTRODUCTION

Transparent, electrically conductive films of indium—tin oxide (ITO) are used in electro-optical devices that need transparent electrodes.¹ ITO films are mainly processed by DC-magnetron sputtering of ITO targets. Dense targets exhibit better characteristics and lead to better films than porous targets² but, unfortunately, In₂O₃-based ceramics do not sinter easily.³ TiO₂ additives greatly improve densification, as reported by Nadaud *et al.*:⁴ for a sintering treatment of 3 h at 1400°C, TiO₂-free ITO densifies to 90% of the theoretical density, whereas 0.5 wt% TiO₂-ITO densifies to nearly 100%. Moreover, TiO₂ reduces the grain growth.

Previous data were related to ITO, whereas the present paper concerns indium oxide. To visualize the influence of TiO_2 additives, the study was carried out using specimens with a graded composition of TiO_2 .

2 EXPERIMENTAL PROCEDURE

The starting powder was 99.99 wt% pure In₂O₃ (Metaleurop Recherche, France). It was ultrasonically dispersed in absolute ethanol and dried under vacuum. Then, TiO₂ was added using an alkoxide precursor (titanium butoxide:

Ti[O(CH₂)₃CH₃]₄). Hydrolytic polycondensation of the titanium butoxide was carried out by adding deionized water, with an excess molar ratio water/alkoxide. The powder mixture was ultrasonically stirred, then dried under vacuum.

Green compacts were pressed to cylindrical pellets (13 mm in diameter and 4 mm in height). The compaction behaviour of the powders was improved by adding a binder (3 wt% of polyvinylbutyral dissolved in hot ethanol) and a plasticizer (0.5 wt% of dibutyl phthalate). Certain pellets were made by stacking two layers of similar thickness (2 mm) against each other. The first layer was TiO₂-free In₂O₃ and the second layer was 2 wt% TiO₂-In₂O₃. The TiO₂-free layer was pressed under 50 MPa, then it was put on to the TiO₂-containing powder bed, and finally the whole assembly was pressed under 150 MPa. A thin platinum wire was put along the interface to help us to locate it in sintered specimens.

Sintering was conducted at temperatures ranging from 1450 to 1550°C, in air, using an MoSi₂-heating element electric oven. Microstructures of polished, thermally-etched samples (etching at 220°C below the sintering temperature, for 30 min) were examined by SEM (Jeol 5200, Japan), using SE or BSE modes. Determination of the TiO₂ content and mapping of the Ti-rich segregations were carried out by EDX (Link Pentafet, UK). Grain size was quantified using the linear-intercept method of Wurst and Nelson.⁵

3 RESULTS AND DISCUSSION

3.1 Influence of TiO₂ on densification

Figure 1 shows the shrinkrage of In₂O₃-based ceramics with 0 or 0.5 wt% TiO₂ versus temperature, for a heating treatment at a constant rate (5°C·min⁻¹). TiO₂-free materials densify poorly and their residual porosity after treatment at 1550°C is about 20%. In contrast, materials with 0.5% or more of TiO₂ sinter to nearly full density. The shrinkage rate peaks at about 1380°C for TiO₂-free materials and at about 1290°C for TiO₂-containing materials.

3.2 Influence of TiO2 on grain growth

Exaggerated grain growth generally leads to a separation of pores from grain boundaries, which

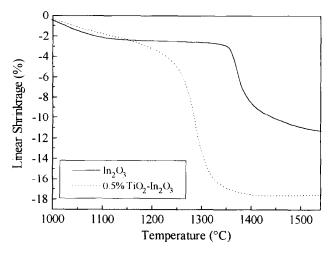


Fig. 1. Shrinkage of x% TiO₂-In₂O₃ (x = 0 and 0.5%) vs temperature (heating rate: $5^{\circ}\text{C}\cdot\text{min}^{-1}$).

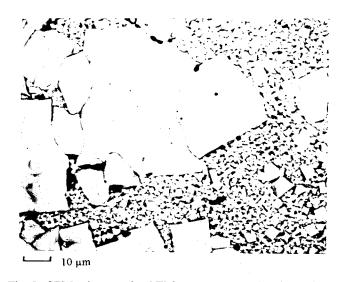


Fig. 2. SEM micrograph of Ti-free In₂O₃ ceramics sintered at 1450°C for 3 h.

results in poor densification. Exaggerated grain growth was observed in TiO_2 -free materials sintered at $1450^{\circ}C$ for times superior to 3 h. Figure 2 shows a duplex microstructure, with both very fine (<3 μ m) and very large (>50 μ m) grains. Temperatures superior to $1450^{\circ}C$ or times superior to 3 h lead to monomodal microstructures, with large grains only.

Figure 3 is a schematic diagram and Fig. 4 is an SEM micrograph of the interfacial zone in a two-layer specimen, sintered at 1550° C for 10 h. Visual observations show that the TiO₂-free layer is light yellow, whereas the 2 wt% TiO₂-containing layer is black. Diffusion has allowed the initially sharp interface to transform to a diffuse interface ($\approx 100~\mu \text{m}$ wide), with a graded concentration of titanium. Consequently, there is a continuous change in grain size and porosity, which is associated with the graded content in TiO₂ (Fig. 5). The

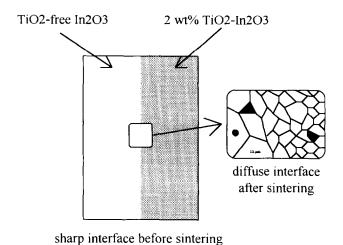


Fig. 3. Schematic diagram of the Ti-rich / Ti-free In₂O₃ interface.

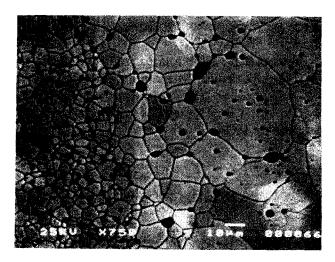


Fig. 4. SEM micrographs of Ti-free/Ti-containing In₂O₃ ceramics sintered at 1550°C for 10 h. Pores appear as black; In₂TiO₅ segregations appear as grey pockets located in trigrain corners.

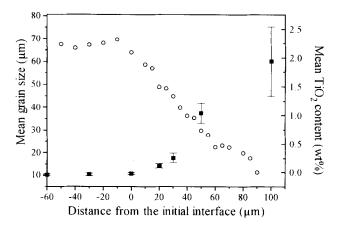


Fig. 5. Mean grain size ((\blacksquare), measured as indicated in Ref. 5) and mean TiO₂ content ((\bigcirc) averaged by EDX on 40 μ m × 40 μ m areas) within the interface zone.

TiO₂-free zone has coarse grains ($\approx 60~\mu m$) with entrapped, round pores and sometimes large voids, whereas the TiO₂-containing zone has uniform, fine grains ($\approx 10~\mu m$), with some intergranular porosity. The solubility limit of TiO₂ in In₂O₃ is about 0.3% and, therefore, there is a precipitation of a TiO₂-rich phase (In₂TiO₅, as characterized by X-ray powder diffraction) when the TiO₂ concentration exceeds this limit. In₂TiO₅ precipitates are segregated in the form of pockets, located in tri-grain corners (Fig. 4).

The present results can be compared to those of Bagley and Lynn Jonhson,⁶ who have reported a grain-size gradient in MgO-containing alumina, due to the volatilization of MgO in the superficial zone of specimens. They have concluded that magnesium in solid solution at grain boundaries controls grain growth without the presence of spinel precipitates. The present results are similar, with a progressive decrease in grain size associated with a progressive increase in Ti concentration, down to a constant, minimum grain size as soon as the second phase develops.

4 CONCLUSIONS

The use of a two-layer specimen has allowed us to visualize the beneficial role of TiO_2 additive in In_2O_3 ceramics to increase densification, reduce normal grain growth, and hinder abnormal grain growth. TiO_2 acts at low concentration (<1%), and its effect saturates when a Ti-rich second phase begins to precipitate.

ACKNOWLEDGEMENTS

The authors gratefully acknowledge Saint-Gobain Recherche, who support this study. They also express special thanks to Dr Monique Nanot, for her continuous help.

REFERENCES

- VOSSEN, J. L., Transparent conducting films. *Phys. Thin Films*, 9 (1977) 1–71.
- GEHMAN, B. L., JONSSON, S., RUDOLPH, T., SCHERER, M., WEIGERT, M. & WERNER, R., Influence of manufacturing process of indium tin oxide sputtering targets on sputtering behavior. *Thin Solid Films*, 220 (1992) 333-6.
- DE WIT, J. H. W., Grain growth and sintering of In₂O₃. Sci. Ceram., 9 (1977) 143-50.
- NADAUD, N., NANOT, M. & BOCH, PH., Sintering and electrical properties of titania- and zirconia-containing In₂O₃-SnO₂ (ITO) ceramics. J. Am. Ceram. Soc., 77(3) (1994) 843-6.
- WURST, J. C. & NELSON, J. A., Lineal intercept technique for measuring grain size in two-phase polycrystal-line ceramics. J. Am. Ceram. Soc., 55(2) (1972) 109.
- BAGLEY, R. D. & LYNN JONHSON, D., Effect of magnesia on grain growth in alumina. In Structure and Properties of MgO and Al₂O₃ Ceramics, Advances in Ceramics, Vol. 10, ed. W. D. Kingery. The American Ceramic Society, Inc., 1984, pp. 666-79.